Synthesis and Thermoelectric Properties of Copper Sulfides via Solution Phase Methods and Spark Plasma Sintering

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Abstract: Large-scale Cu$_2$S tetradecahedrons microcrystals and sheet-like Cu$_2$S nanocrystals were synthesized by employing a hydrothermal synthesis (HS) method and wet chemistry method (WCM), respectively. The morphology of α-Cu$_2$S powders prepared by the HS method is a tetradecahedron with the size of 1–7 µm. The morphology of β-Cu$_2$S is a hexagonal sheet-like structure with a thickness of 5–20 nm. The results indicate that the morphologies and phase structures of Cu$_2$S are highly dependent on the reaction temperature and time, even though the precursors are the exact same. The polycrystalline copper sulfides bulk materials were obtained by densifying the as-prepared powders using the spark plasma sintering (SPS) technique. The electrical and thermal transport properties of all bulk samples were measured from 323 K to 773 K. The pure Cu$_2$S bulk samples sintered by using the powders prepared via HS reached the highest thermoelectric figure of merit (ZT) value of 0.38 at 573 K. The main phase of the bulk sample sintered by using the powder prepared via WCM changed from β-Cu$_2$S to Cu$_{1.8}$S after sintering due to the instability of β-Cu$_2$S during the sintering process. The Cu$_{1.8}$S bulk sample with a Cu$_{1.96}$S impurity achieved the highest ZT value of 0.62 at 773 K.

Keywords: Cu$_2$S; nanocrystal; synthetic methods; morphological control; thermoelectric properties

1. Introduction

Thermoelectric (TE) material is a kind of energy conversion material which takes advantage of solid material internal carriers and phonon interactions to convert thermal and electrical energy directly into each other. The energy crisis and environmental problems have promoted the swift development of TE materials in the past few decades [1–4]. Compared to the mainstream tellurium-based TE materials [5–8], nanostructured metal chalcogenides with low cost, low toxicity, and abundant elements exhibit interesting physical properties [9,10]. Therefore, nanostructured metal chalcogenides TE materials such as Cu-Se [11–13] and Cu-S materials [14–17] have received more attention.

Copper sulfides (Cu$_2$−$x$S (0 ≤ x ≤ 1)), with different copper stoichiometric ratios, which are a series of compounds ranging from copper-rich Cu$_2$S to copper deficient CuS, are considered to be superionic conductors [18]. As an important semiconductor, Cu$_2$S is of high interest due to its unique electronic, thermodynamic, optical, and other physical and chemical properties. It has great potential in a wide range of applications such as thermoelectric materials [19], solar cells [20,21], conductive fibers [22], optical filters [23], and high-capacity cathode materials in lithium secondary batteries [24]. Moreover, Cu$_2$S nanoparticles with various morphologies have been synthesized by various approaches such as chemical precipitation [25], solventless thermolysis [26], water-oil interface confined method [27], and thermal decomposition [28].
Here, we employed facile solution methods, including hydrothermal synthesis (HS) and wet chemistry method (WCM), to synthesize Cu$_2$S powders with controllable microstructures under relatively facile conditions. Then, polycrystalline copper sulfides were fabricated by densifying the compound powders using the spark plasma sintering (SPS) technique. The thermoelectric properties of all the bulk samples were measured.

2. Experimental Section

Commercial high-purity powders of CuO (99.9%) and S (99.99%) were used as raw materials. Meanwhile, ethylene diamine (EDA) and hydrazine hydrate (N$_2$H$_4$·H$_2$O) were used as a chelating agent (EDA) and a reducing agent (N$_2$H$_4$·H$_2$O), respectively. In a typical wet chemistry method, CuO (10 mmol) and S (20 mmol) were first added to EDA (40 mL) by stirring at room temperature for 10 min. Then, N$_2$H$_4$·H$_2$O (35 mL) was dripped slowly into the beaker under further stirring for 12 h at room temperature. The chelating agent EDA reacted with Cu ions to form the complex compounds for avoiding the precipitation of metal Cu. The reducing agent N$_2$H$_4$·H$_2$O reduced the Cu$^{2+}$ to Cu$^+$ and S to S$^{2-}$, respectively.

In a typical hydrothermal synthesis [29] method, CuO (10 mmol) and S (20 mmol) were first added to EDA (40 mL), and the mixture was stirred and heated to 373 K for 10 min. After that, N$_2$H$_4$·H$_2$O (35 mL) was dripped slowly into the solution under further stirring for 10 min at 373 K. The mixed solution was then transferred into a Teflon-lined stainless steel autoclave (100 mL capacity), which was sealed and maintained at 453 K for 6 h. The final solid products were filtered and washed with DI water and ethanol three times before drying under vacuum at 333 K for 12 h.

The resultant powders were loaded into a graphite die with an inner diameter of 15 mm and then sintered at 773 K for 5 min (heating rate of 100 K/min) under an axial compressive stress of 40 MPa in a vacuum by using a spark plasma sintering (SPS) system (SPS1050; Sumitomo, Tokyo, Japan). The SPS-prepared specimens were disk-shaped with dimensions of Φ15 mm × 4 mm. The phase structure was analyzed by X-ray diffraction with a Cu K$_\alpha$ radiation (λ = 1.5406 Å) filtered through Ni foil (RAD-B system; Rigaku, Tokyo, Japan). The morphologies of the powders and the fracture of the bulk samples were observed by field-emission scanning electron microscopy (FESEM, SUPRA 55, Carl Zeiss, Oberkochen, Germany). The microstructure of the powder was also checked using transmission electron microscopy (TEM, Philip Tecnai F20, Amsterdam, Dutch). In a typical TEM sample preparation procedure, powders were first added to ethyl alcohol, and stirred for 10 min by ultrasound. Then, the supernatant was dropped on the copper grid.

The electrical transport properties were evaluated along a sample section perpendicular to the SPS pressing direction. The Seebeck coefficient and electrical resistivity were measured from 323 to 773 K in a helium atmosphere using a Seebeck coefficient/electrical resistance measuring system (ZEM-3, Ulvac-Riko, Kanagawa, Japan). The density ($d$) of the sample was measured by the Archimedes method. In addition, the thermal conductivity of the samples was calculated by the relationship $\kappa = DC_p/d$ from the thermal diffusivity $D$ measured by the laser flash method (LFA457; NETZSCH, Selb, Bavaria, Germany).

3. Results and Discussion

3.1. Powder Synthesis and Characterization

3.1.1. XRD Analysis

Figure 1 shows the XRD patterns of Cu$_2$S powders which prepared by WCM and HS methods. All of the diffraction peaks of the HS sample are well-matched with the standard card of α-Cu$_2$S (JSPDS no. 83-1462), showing that the pure monoclinic α-Cu$_2$S powders were obtained by HS methods. All of the diffraction peaks of the WCM sample are well-matched with the standard card β-Cu$_2$S (JCPDS no. 26-1116), showing that the pure hexagonal β-Cu$_2$S powders were obtained by WCM.
Actually, the hexagonal $\beta$-Cu$_2$S is high-chalcocite (378–698 K); it would be not stable under thermal shock. The diffraction peaks of powder samples are wider compared to the standard card, indicating the small grain size of the obtained powder. The XRD refinement was performed for the two samples as shown in Figures S1 and S2. The location, proportion and lattice constant of experiment and refinement Cu ions for hexagonal $\beta$-Cu$_2$S powder are shown in Table S1. The proportion of Cu1 changed from 0.75 to 0.4896, indicating that there are more Cu vacancies, smaller lattice parameters, and the possibility of defects in hexagonal Cu$_2$S.

![XRD patterns](image)

**Figure 1.** XRD patterns with a selected 20 range of 20°–70° for Cu$_2$S powders.

3.1.2. FESEM and TEM Analysis

Figure 2 shows the FESEM images of Cu$_2$S prepared by different synthesis methods. The pure $\alpha$-Cu$_2$S powder which was prepared by the HS method is shown in Figure 2a. The morphology of $\alpha$-Cu$_2$S powder prepared by the HS method is a tetradecahedron with the size of 1–7 µm. Figure 2b is a magnified image of a typical single-crystalline $\alpha$-Cu$_2$S, shown in Figure 2a. The pure $\beta$-Cu$_2$S powder which was prepared by WCM is shown in Figure 2c. The morphology of hexagonal $\beta$-Cu$_2$S is hexagonal nanosheets. Each nanosheet has an edge length of 10–200 nm and a thickness of 5–20 nm. The morphologies of the powder are highly related to the crystal structure [30]. Similar work reported in the literature for molybdate materials [31] suggests that the synthesis temperature has a strong influence on the morphology of Cu$_2$S samples. Under the synthesis conditions of high temperature and high pressure, the monoclinic $\alpha$-Cu$_2$S showed a tetradecahedron morphology. Also, under relatively mild synthesis conditions (WCM), the hexagonal $\beta$-Cu$_2$S nanosheets were synthesized at room temperature.

The high magnification FEM image of $\beta$-Cu$_2$S is shown in Figure 2d. The $\beta$-Cu$_2$S has a hexagonal sheet-like structure with a thickness of 20 nm. The TEM image (Figure 3a) and selected area of electron diffraction (SAED) patterns (Figure 3b) of a single crystal $\alpha$-Cu$_2$S revealed a tetradecahedron Cu$_2$S of 1 µm in width. The SAED pattern for the tetradecahedron particles (Figure 2b) indicated a highly crystallized monoclinic structure of the $\alpha$-Cu$_2$S. Additionally, the TEM image (Figure 3c) and SAED patterns (Figure 3d) of a single-crystalline $\beta$-Cu$_2$S revealed a sheet-like Cu$_2$S of 10–200 nm in width and of 5–20 nm in thickness. The results are in agreement with SEM observations.
3.1.3. Synthesis Mechanism

The synthesis process and mechanism of Cu$_2$S, similar to the flower-like $\alpha$-Fe$_2$O$_3$ reported by Penki et al. [32], were investigated in detail, as shown in Figure 4. The raw CuO (black) and S (yellow) were mixed in a N$_2$H$_4$·H$_2$O and EDA solution to initially produce the precursor Cu$_2$O and S$^{2-}$, and then further react to become the product Cu$_2$S under the different reaction conditions. When the HS method was employed, the reaction temperature was 453 K and the product was monoclinic $\alpha$-Cu$_2$S, as indicated in XRD shown in Figure 1. After 6 h of hydrothermal reaction, the single crystal monoclinic $\alpha$-Cu$_2$S formed a tetradecahedron with a dimension of several micrometers as shown in Figure 2a. But when WCM was employed with a reaction temperature of room temperature, the product was hexagonal $\beta$-Cu$_2$S, as indicated in XRD shown in Figure 1. After a 12-h reaction,
the single crystal hexagonal $\beta$-Cu$_2$S grew to form nanosheets with an edge length of 10–200 nm and thickness of 5–20 nm as shown in Figure 2c. The reaction process can be described by Equations (1)–(3).

$$2\text{CuO} + 2\text{N}_2\text{H}_4\cdot\text{H}_2\text{O} \rightarrow \text{Cu}_2\text{O} + 2\text{NH}_4^+ + \text{H}_2\text{O} + 2\text{OH}^- + \text{N}_2\uparrow \quad (1)$$

$$\text{S} + 2\text{N}_2\text{H}_4\cdot\text{H}_2\text{O} \rightarrow \text{S}^{2-} + 2\text{NH}_4^+ + 2\text{H}_2\text{O} + \text{N}_2\uparrow \quad (2)$$

$$2\text{Cu}_2\text{O} + 2\text{S}^{2-} + 2\text{H}_2\text{O} \rightarrow 2\text{Cu}_2\text{S} + 4\text{OH}^- \quad (3)$$

Finally, it is suggested that the morphologies and phase structures of Cu$_2$S are highly dependent on the reaction temperature and time, even if precursors are exactly the same.

3.2. Bulk Characterization

3.2.1. XRD and FESEM Analysis

The bulk sample abbreviated as HS-bulk was prepared by applying SPS at 773 K for 5 min using monoclinic $\alpha$-Cu$_2$S powders. The bulk sample abbreviated as WCM-bulk was prepared by applying SPS at 773 K for 5 min using hexagonal $\beta$-Cu$_2$S powders. The XRD patterns of those bulk samples are shown in Figure 5a. The green arrows index the impurity peaks of Cu$_{1.96}$S. The HS-bulk is still in the $\alpha$-Cu$_2$S phase. The SEM image of HS-bulk shown in Figure 5b shows a high relative density of 96% and an average grain size of 5 $\mu$m, which is very similar to the powders formed by the rapid sintering process. SPS is a rapid sintering technology, after which the nanoscale particles can be maintained in bulk [14]. As shown in the XRD pattern (Figure 5a), the WCM-bulk exhibits a main phase of Cu$_{1.8}$S with an impurity of Cu$_{1.96}$S. The hexagonal $\beta$-Cu$_2$S is in the high-chalcocite phase, which is instable during the sintering process. Because of thermal shock in the SPS process, the phase transition occurred from $\beta$-Cu$_2$S to Cu$_{1.8}$S, which is the most stable phase in the Cu-S system. Cu$_2$S is a superionic conductor, and the superionic phase transition temperature is over 689 K [33]. In the SPS sintering program, the sintering temperature is 773 K, and the Cu ions show liquid behavior under this temperature. The extra Cu may precipitate on the anode and be removed during the polishing and cutting process. As shown in Figure 5c, the WCM-bulk sample with a relative density of 90.2% has an average size of 200 nm.

Figure 4. Schematic illustration of the growth mechanism of the Cu$_2$S powders synthesized by the WCM and HS methods.
3.2.2. Thermoelectric Transport Properties

The TE properties of the two bulk samples were measured. The TE properties of Cu$_{1.8}$S bulk sample in the literature [34], which were prepared by the same SPS process but using the mechanical alloying (MA) treated powders, are shown for comparison. Figure 6a illustrates the temperature dependence of electrical conductivity ($\sigma$) for the bulk samples. As shown in Figure 6a, the HS-bulk has the highest $\sigma$ value up to 218 Scm$^{-1}$ at 373 K, and WCM-bulk has the highest $\sigma$ value up to 2490 Scm$^{-1}$ at 373 K. Both the HS-bulk and the WCM-bulk have lower $\sigma$ than the MA-bulk. The WCM-bulk has a similar main phase to the MA-bulk but a low relative density and impurity of Cu$_{1.96}$S, which decrease the $\sigma$ value. The HS-bulk sample has the main phase of Cu$_2$S, while the electrical conductivity of Cu$_{2-x}$S depends on the Cu content due to its superionic behavior. Therefore, the HS-bulk sample has the lowest electrical conductivity. The WCM-bulk sample has one turning point in the $\sigma$ curve due to the one phase transition of Cu$_{1.96}$S during the measured temperature range of 323 K to 773 K [34]. Two turning points in the $\sigma$ curve were observed for the HS-bulk sample due to the two phase transitions of Cu$_2$S during the measured temperature range. As reported by Li et al., bulk Cu$_2$S exhibits three phases ($\alpha$-phase, $\beta$-phase, $\gamma$-phase) in the temperature ranges of >698, 378–698, and <378 K [35,36], respectively. The high temperature region to the right of the blue dashed line in Figures 6 and 7 is the $\gamma$-phase.

The positive Seebeck coefficient ($\alpha$) in Figure 6b indicates all bulks are $p$-type semiconductors. According to the equations $\alpha = e\mu n$, and $\alpha \approx \gamma - 1/n\mu$, [37] where $\sigma$, $\mu$, $n$, $\alpha$ and $\gamma$ are electrical conductivity, carrier mobility, carrier concentration, Seebeck coefficient and scattering factor, respectively, $\alpha$ is usually inversely proportional to $\sigma$. The HS-bulk achieved the largest $\alpha$ value of 532 $\mu$VK$^{-1}$ at 673 K. The WCM-bulk achieved the largest $\alpha$ value of 101 $\mu$VK$^{-1}$ at 773 K. The $PF$ was calculated by $PF = \alpha^2\sigma$ and is shown in Figure 6c. The $PF$ of the HS-bulk reaches 196 $\mu$Wm$^{-1}$K$^{-2}$ at 573 K, and that of the WCM-bulk achieved 985 $\mu$Wm$^{-1}$K$^{-2}$ at 773 K.
Figure 6. Temperature dependence of electrical conductivity (a); Seebeck coefficient (b); and power factor (c) for the two bulk samples and the reference [34].

Figure 7 shows the temperature dependence of thermal conductivity ($\kappa$) (a) and the thermoelectric figure of merit, ZT (b). The $\kappa$ value of the HS-bulk and the WCM-bulk are lower than that of the MA-bulk [34], due to the fine grain size and the lower relative density. The HS-bulk sample obtained the lowest $\kappa$ value of 0.20 WmK$^{-1}$ at 673 K. The WCM-bulk sample obtained the lowest $\kappa$ value of 1.23 WmK$^{-1}$ at 773 K. The $\kappa$ curve of the HS sample also has two turning points according to the two phases transitions of Cu$_2$S, which are also similar to the previous report by He et al. [33]. Based on the above measurement results, the $ZT$ was calculated by:

$$ZT = \frac{\sigma \alpha^2 T}{\kappa}$$

as shown in Figure 7b. The highest $ZT$ value of 0.38 was obtained at 573 K for the HS-bulk sample, and the WCM-bulk sample obtained the highest $ZT$ value of 0.62 at 773 K. This shows that Cu$_2$S is a promising thermoelectric material, and the method combining the solution phase method and SPS may be an efficient route for synthesizing high performance bulk TE materials [37].
Figure 7. Temperature dependence of thermal conductivity (a) for the two bulk samples and ZT value and (b) for the two bulk samples and the reference [34].

4. Conclusions

The stable solution phase processes for preparing the single phase Cu$_2$S powders were obtained. Large-scale Cu$_2$S tetradecahedron microcrystals with monoclinic symmetry and sheet-like Cu$_2$S nanocrystals with hexagonal $\beta$-Cu$_2$S symmetry were synthesized by employing the hydrothermal synthesis (HS) method and the wet chemistry method (WCM), respectively. The Cu$_2$S nanopowders were densified to bulk by SPS. Due to the fine grains, low thermal conductivity was achieved, resulting in enhanced TE properties. The highest ZT value of 0.38 was obtained at 573 K for the HS-bulk sample, which is better than the values achieved by the other two samples in this temperature. The WCM-bulk sample obtained the highest ZT value of 0.62 at 773 K. Compared with the MA-bulk [34], the WCM-bulk has a 26.53% increase of ZT value at 773 K. Our work indicated that the morphologies and phase structures of Cu$_2$S are highly dependent on the reaction temperature and time even when the raw materials were exactly the same.

Supplementary Materials: The following are available online at http://www.mdpi.com/2073-4352/7/5/141/s1, Figure S1: XRD refinement patterns of the hexagonal Cu$_2$S powder sample, Figure S2: XRD refinement patterns of the monoclinic Cu$_2$S powder sample, Table S1: The location, proportion and lattice constant of Cu ions, Table S2: The lattice constant of monoclinic Cu$_2$S powder sample.

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